

Electronic Patent Application Fee Transmittal

Application Number:	10500111			
Filing Date:	27-May-2005			
Title of Invention:	BINDER RESIN COMPOSITIONS, PRODUCTION PROCESS AND USE THEREOF			
First Named Inventor/Applicant Name:	Naosuke Komoto			
Filer:	Marvin Jay Spivak/sinee samla			
Attorney Docket Number:	254918US0PCT			
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
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Patent-Appeals-and-Interference:				
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